

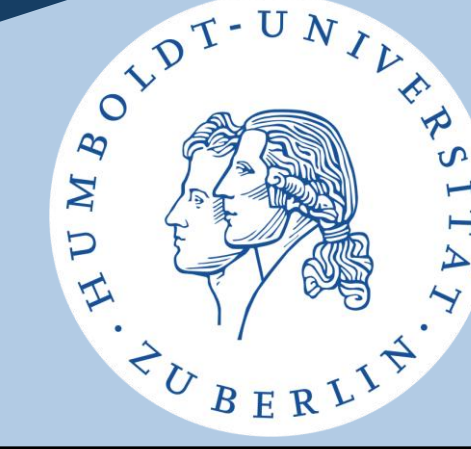
Current and low-field carrier mobility in silicon sensors irradiated to extreme fluences

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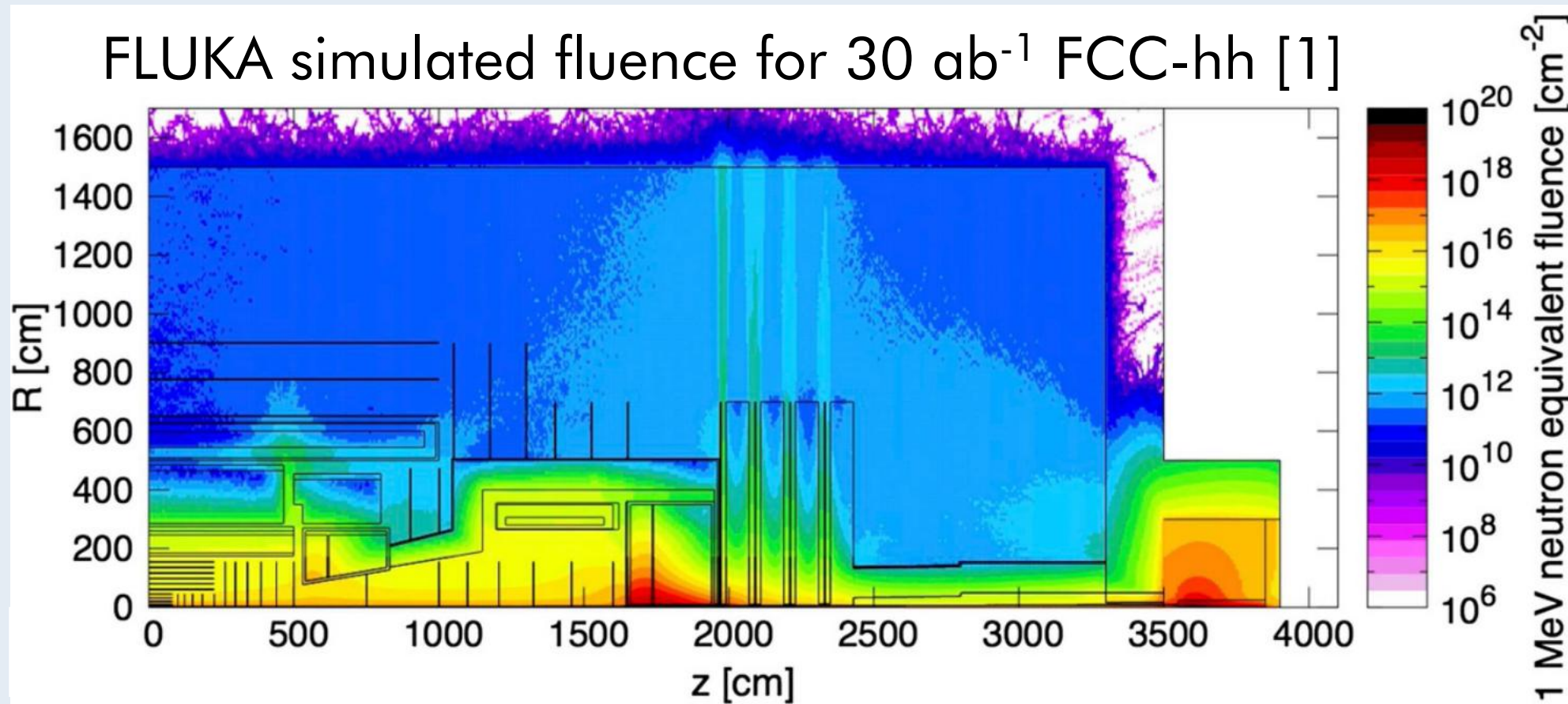
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Introduction

Silicon is the material of choice for highly granular and radiation-hard detectors. However, at the innermost tracking layers of the **FCC-hh**, particle fluences are expected to reach up to $6 \cdot 10^{17} \text{ n}_{\text{eq}}/\text{cm}^2$



Defect introduction rates typically $\sim 1 \text{ cm}^{-1}$, leading to:

- Defect concentrations $\sim 6 \cdot 10^{17} \text{ cm}^{-3} \gg$ initial doping concentration $\sim 10^{13} \text{ cm}^{-3}$
- As original doping becomes compensated, sensor behavior changes drastically

Is silicon still a viable option for FCC-hh?

➔ We must study the effects of extreme radiation damage

Method

Goal:

Understand how extreme fluences alter silicon sensor electrical properties and whether radiation-damage models for TCAD can reproduce those changes

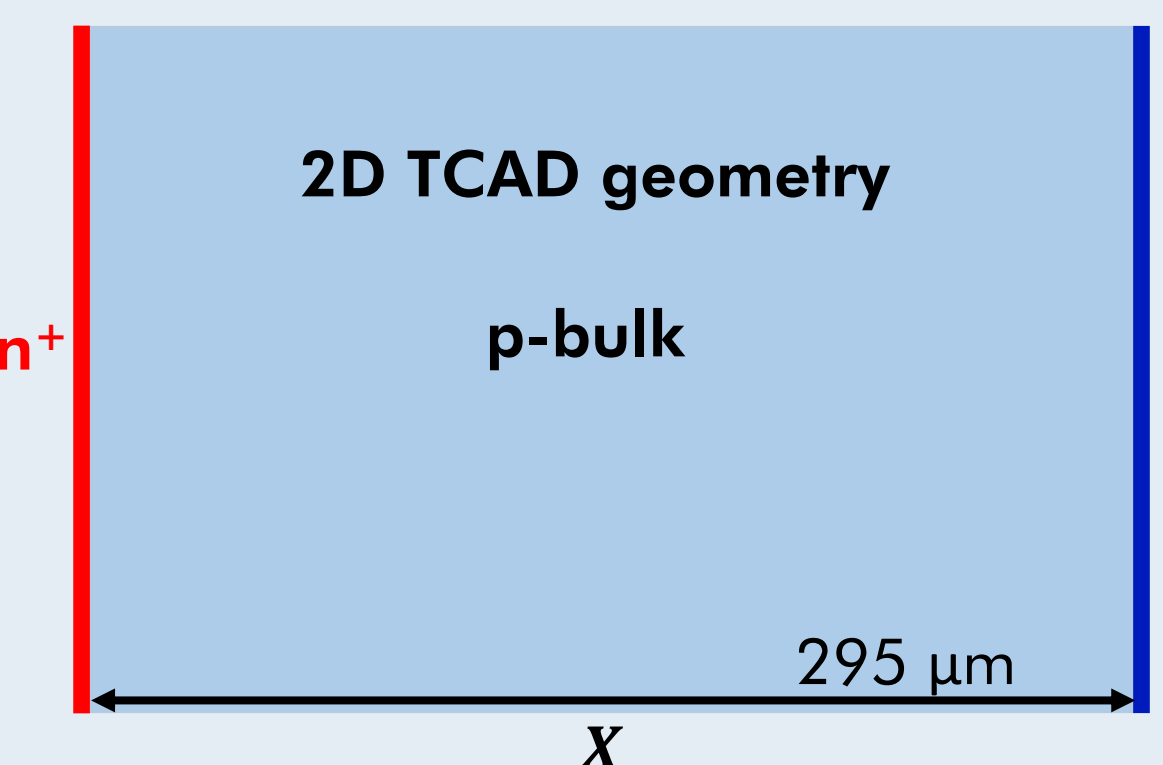
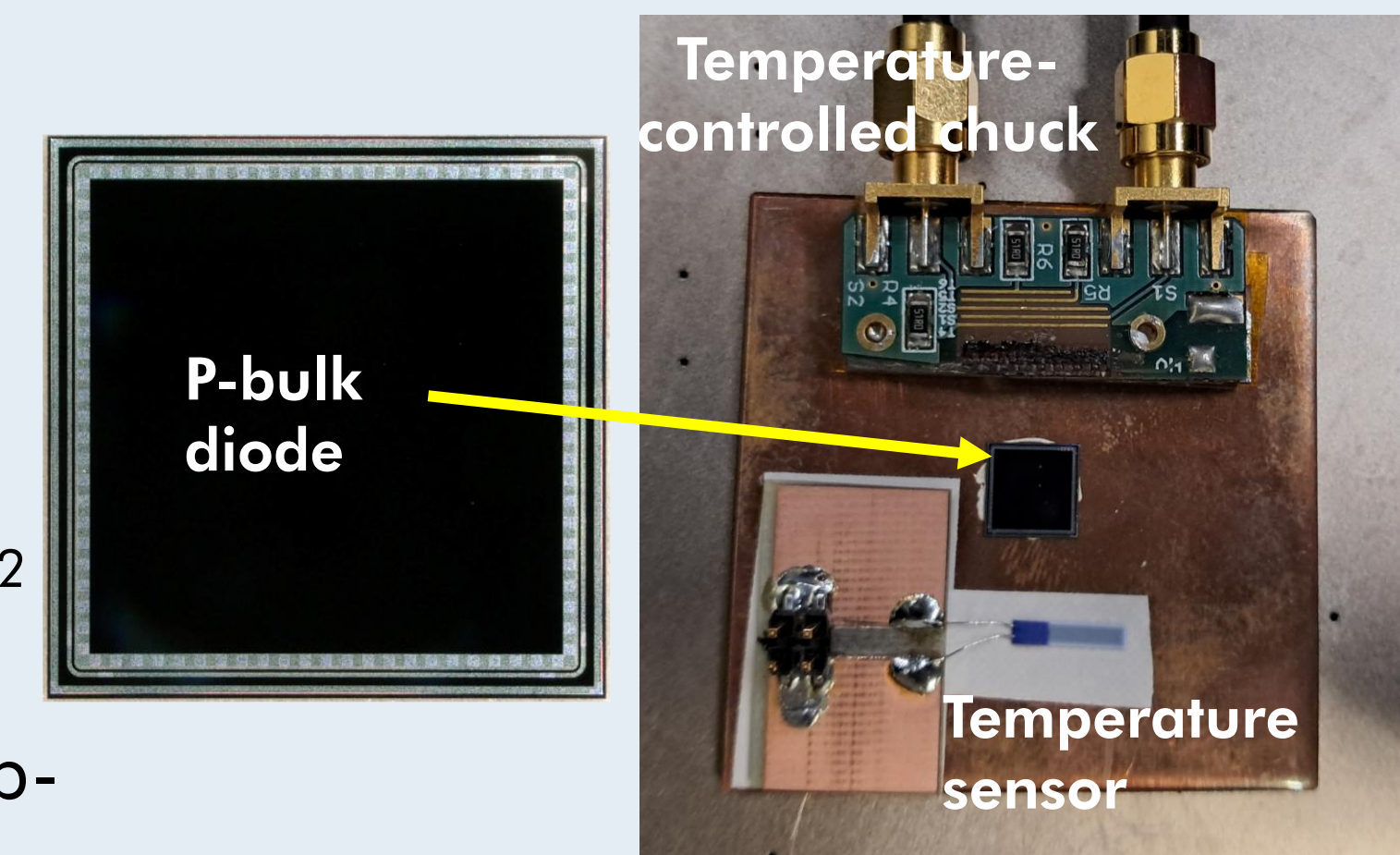
Measurements:

- I-V and C-V on ATLAS ITk Strip $8 \times 8 \text{ mm}^2$
- $n^+ - p - p^+$ diodes
- $295 \mu\text{m}$ active bulk with $4 \times 10^{12} \text{ cm}^{-3}$ p-type doping
- Irradiated to 2.3×10^{17} and $5.0 \times 10^{17} \text{ n}_{\text{eq}}/\text{cm}^2$ with neutrons (JSI, Ljubljana)

Simulations:

- Synopsys TCAD: simple 2D pad geometry
- Effective HPTM* [2] and Perugia [3] bulk defect models

*) Modified by activating Poole-Frenkel field-enhanced emission

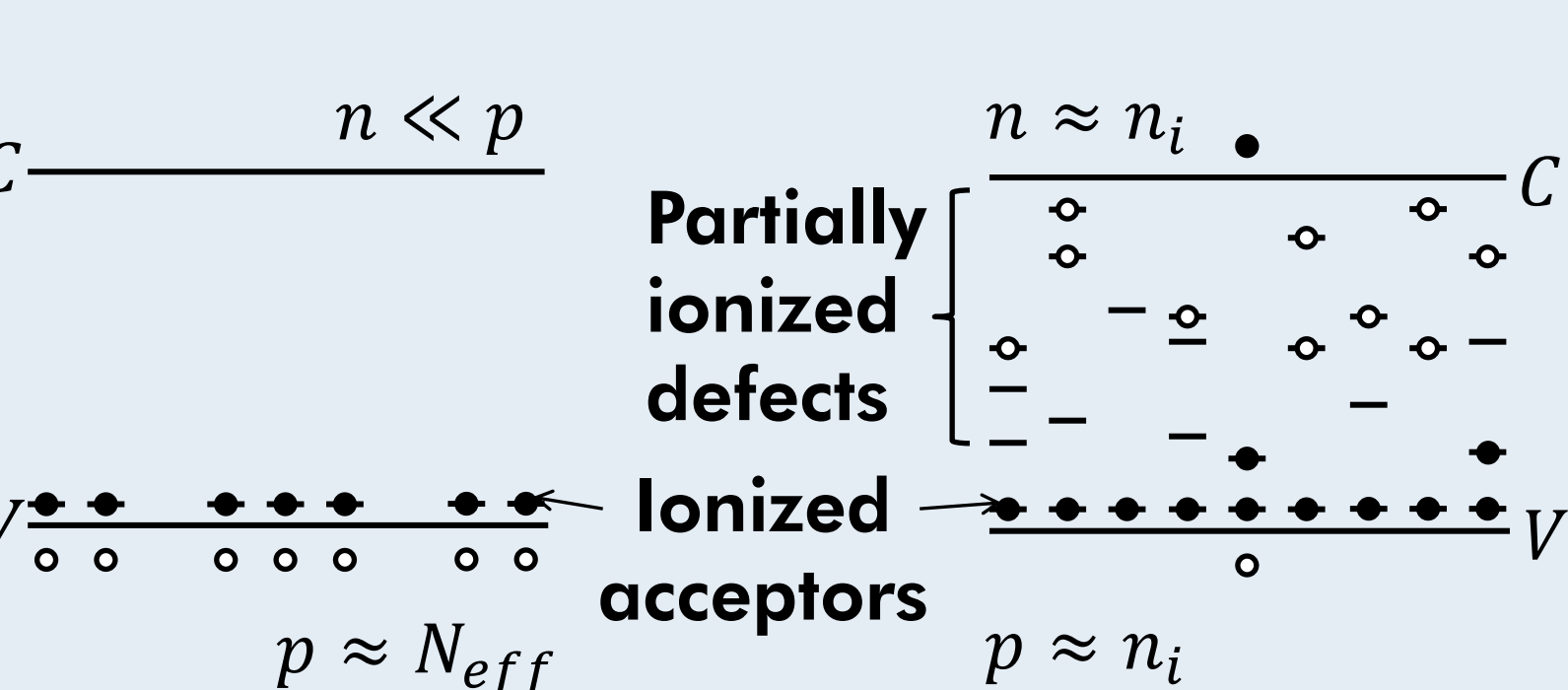


What we already knew

Bulk band structure in equilibrium

Non-irradiated

Irradiated



High concentration of radiation-induced defects in the band gap

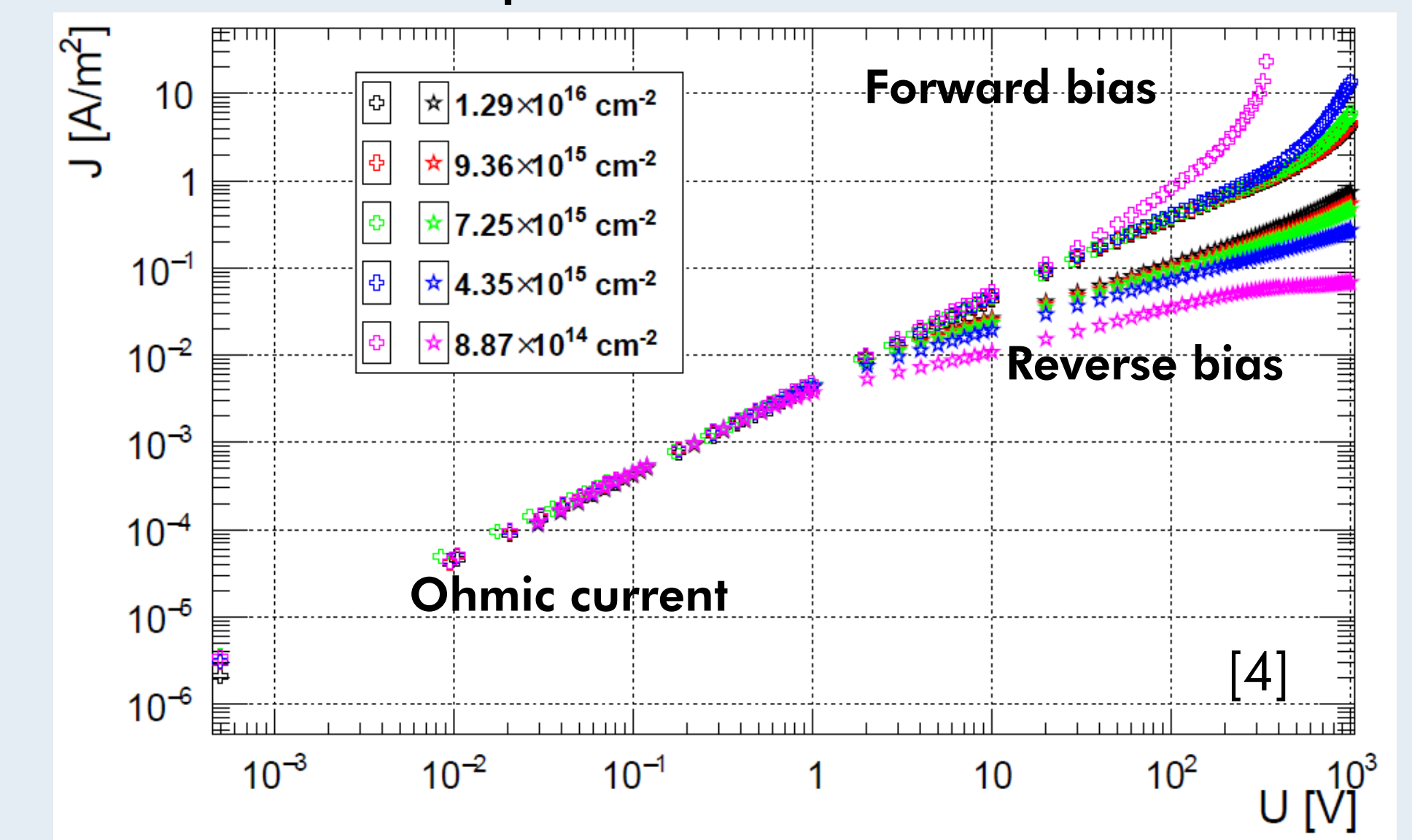
Equilibrium ($U_{\text{bias}} = 0 \text{ V}$)

- Excess carriers captured by defects
- Bulk doping and oxide charge compensated by deep defects
- Free carrier concentrations become intrinsic in equilibrium
- Mobilities decrease due to ionized-defect scattering

Steady state ($U_{\text{bias}} \neq 0 \text{ V}$)

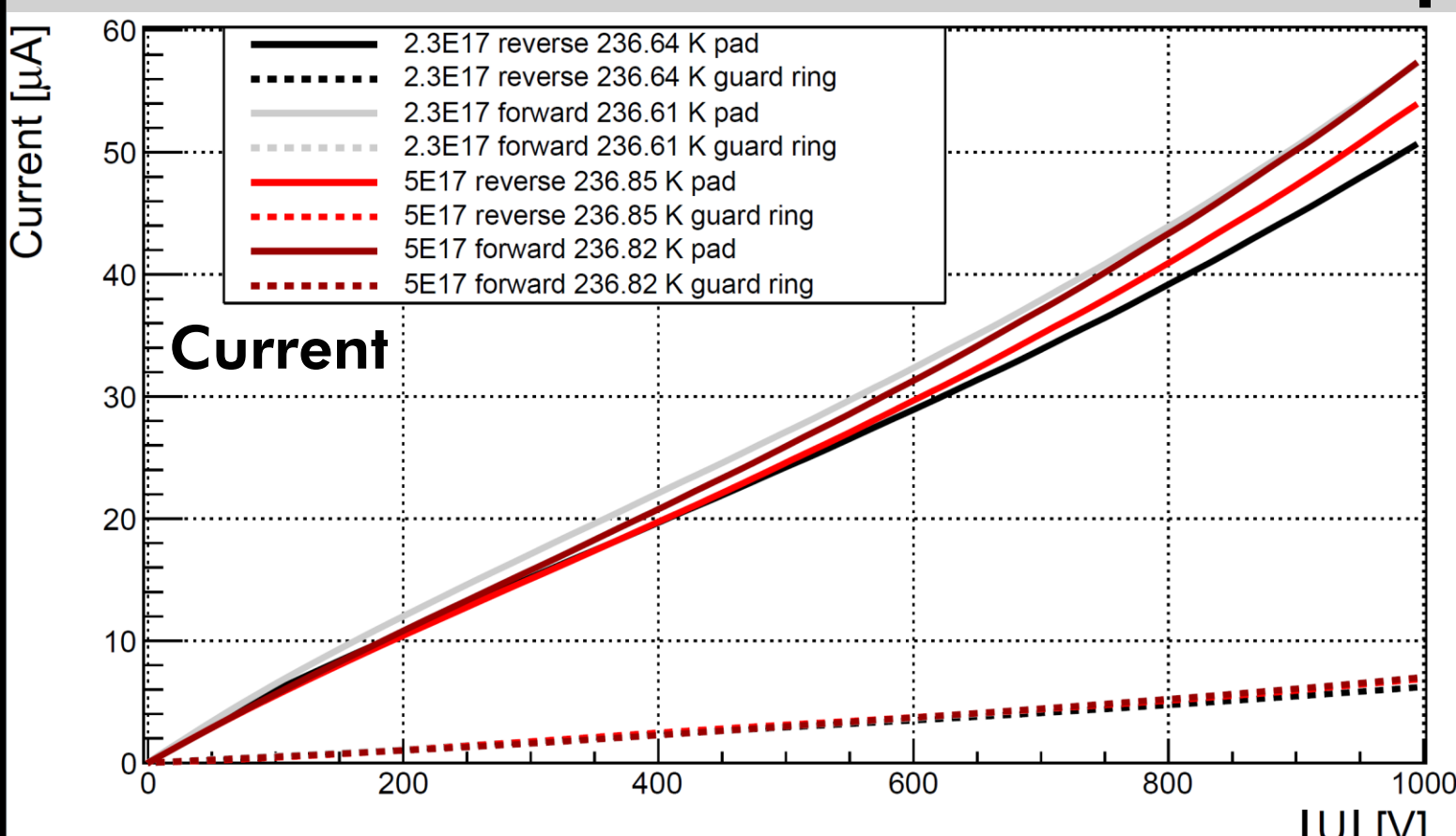
- Space-charge region (SCR) development suppressed
- Thin SCR regions with very high space charge concentrations
- SCR generation has limited influence on the current
- Bulk stays near-intrinsic even at high electric field

Current of 24 GeV/c proton-irradiated n-bulk diodes at 243 K



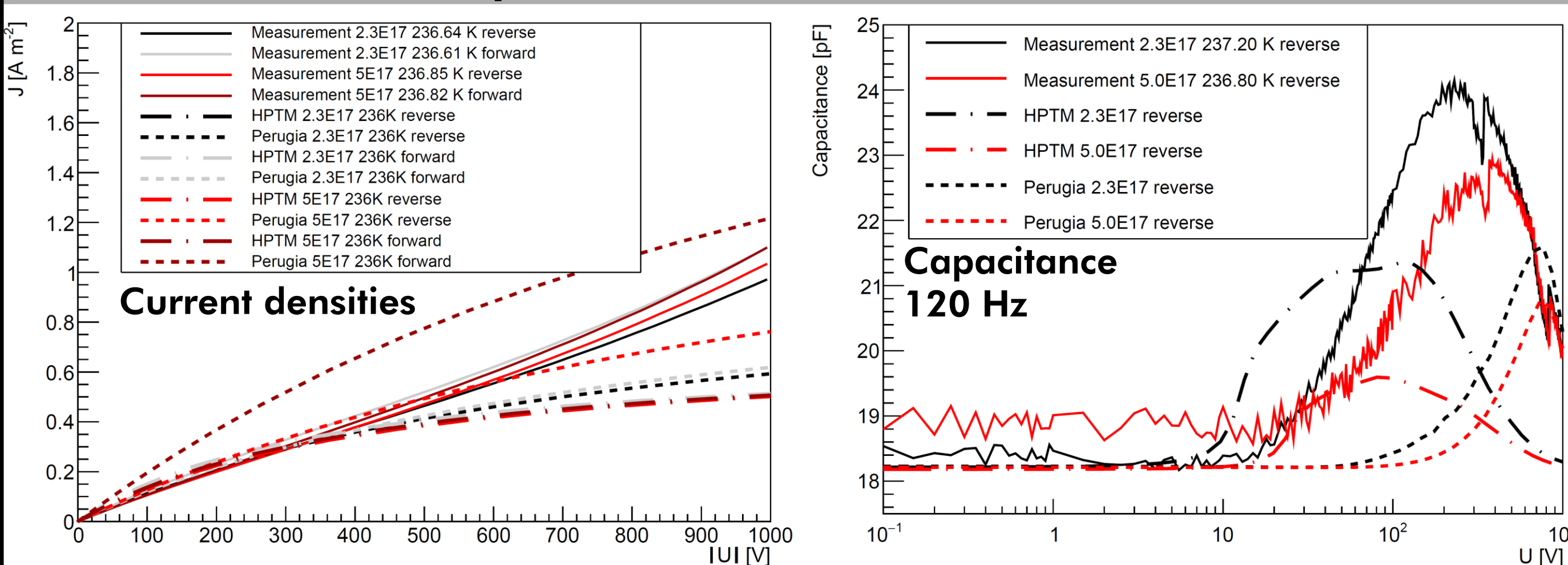
Results

Current and capacitance



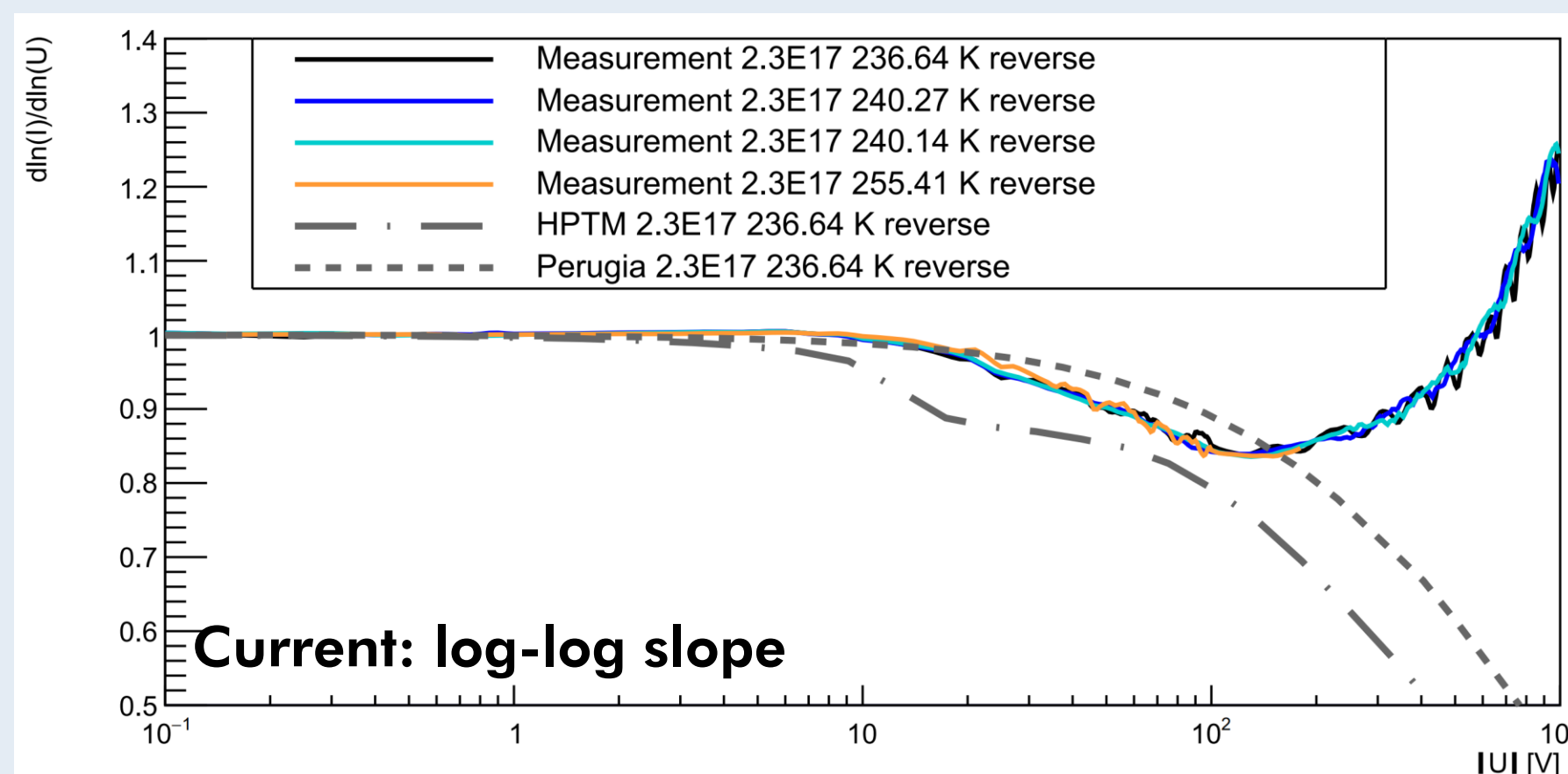
- Current very similar for forward and reverse bias and no major change between for the two fluences
- Guard ring current very low
- No major influence of surface currents

Comparison with TCAD simulations



TCAD radiation-damage models reproduce only **order of magnitude** of the measured current and capacitance, not the voltage dependence

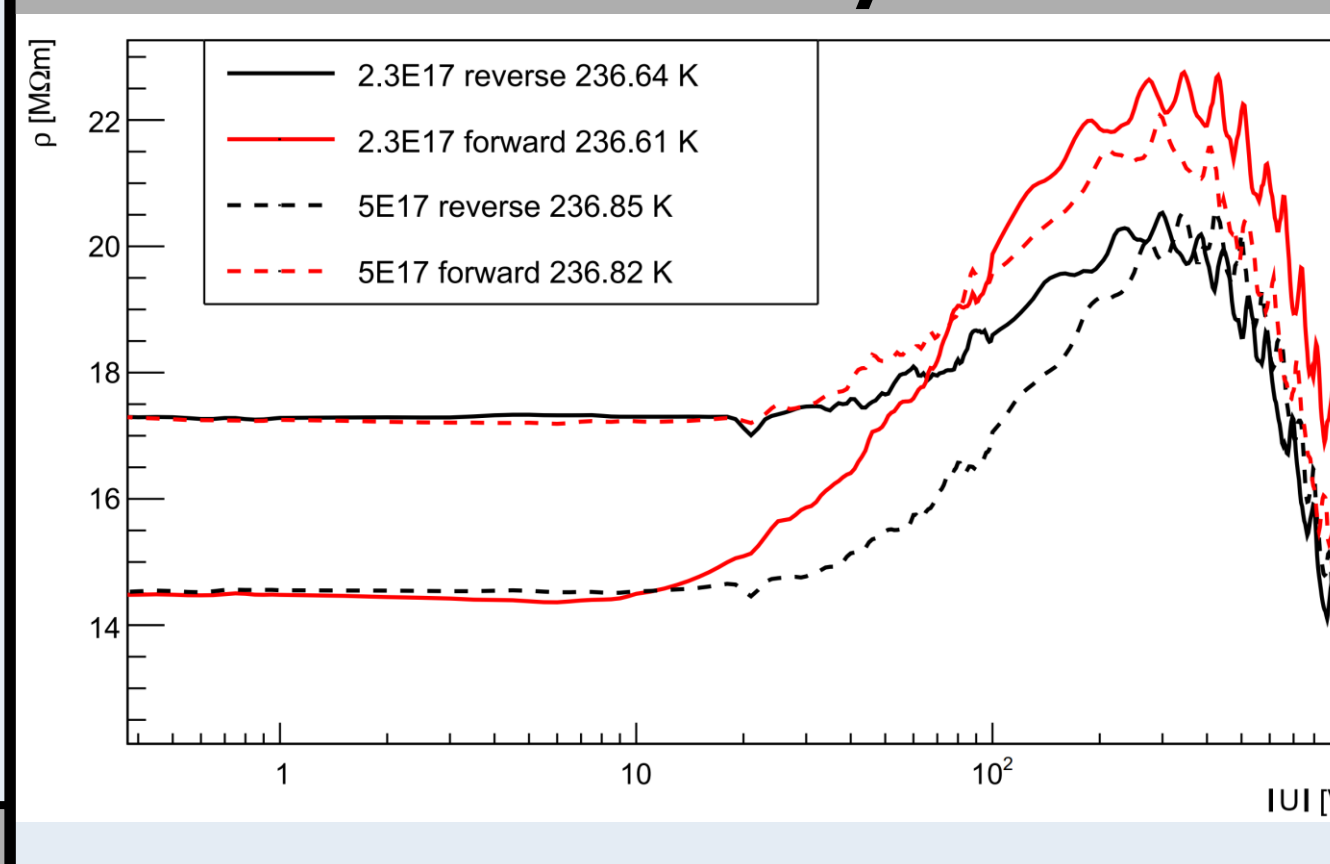
- Perugia model predicts **reverse** trend for forward current
- Excluded from further considerations in this work
- HPTM model promising:
- Main features of the measurements reproduced for $|U| < 100 \text{ V}$



- Exponential current increase at high bias voltages not reproduced by damage models
- The shape seems not to depend on the temperature
- Increase could be due to SRH generation from cluster defects
- **Needs further study and improved damage models!**

Resistivity and mobility

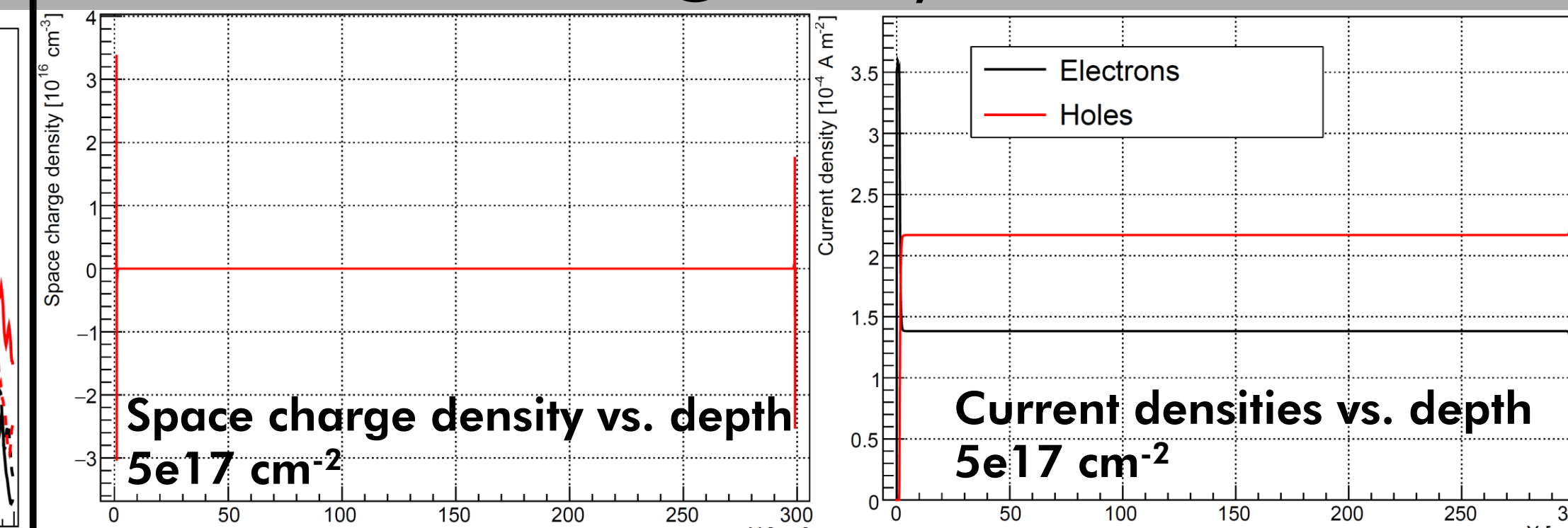
Resistivity



- **Resistivity** at low voltages **increases with fluence** due to reduction of the carrier mobilities

- Resistivity increases at intermediate voltages
- **Reduction of $\mu_{e,h}(E)$ with E**
- SCR grows marginally, increasing resistivity

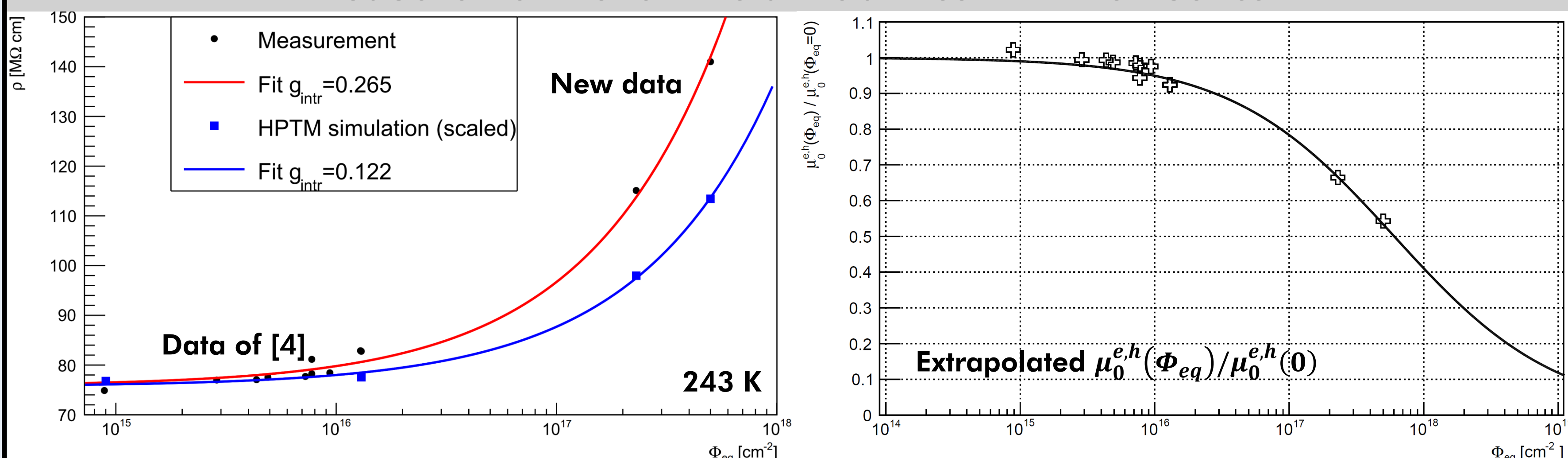
HPTM simulation @ 243 K, 0.1 V reverse bias



Fluence [cm⁻²]	5×10^{17}	2.3×10^{17}	1.3×10^{16}	9×10^{14}
μ_e [Vs/cm²]	1361	1651.5	2249.1	2369
μ_h [Vs/cm²]	534.9	602.8	724.5	743.5
n [10^7 cm^{-3}]	1.89	1.88	1.88	1.77
p [10^7 cm^{-3}]	7.53	7.55	7.57	8.02
J [10^{-4} A/m^2]	3.54	4.10	5.18	5.23
n_i/n_e	2.00	2.00	2.01	2.13
n_i/n_h	0.501	0.499	0.498	0.470

- Naïve resistor expectation $J_e(x) = J_h(x) = \text{const}$ not fulfilled, but:
- **Current densities** in the bulk are **constant**
- **n, p** in the bulk **independent of the fluence**

Reduction of the low-field mobilities with the fluence



- We don't need to know true steady-state bulk carrier concentrations, assuming n, p are independent of Φ_{eq} and $\mu_0^{e,h}(\Phi_{eq})$ scale equally for e, h
- Approximate empirical Masetti formula [5] to scale $\mu_0^{e,h}(\Phi_{eq})$, using $N_{ref} = 1.6 \times 10^{17} \text{ cm}^{-3}$ and $\alpha = 0.715$:

$$\rho(\Phi_{eq}) = \frac{1 + \left(\frac{g_{intr} \cdot \Phi_{eq}}{N_{ref}} \right)^\alpha}{e(n\mu_0^e + p\mu_0^h)}$$

- [1] cds.cern.ch/record/2651300
[2] doi.org/10.1109/NSSMIC.2018.8824412
[3] doi.org/10.1016/j.nima.2022.167180 Fig. 1
[4] bib-pubdb1.desy.de/record/410589
[5] doi.org/10.1109/T-ED.1983.21207

